



Product Specification

Part No.: SCD-413

1) Rating: DC 30V 0.3A

2) Operating Temperature Range: $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$

3) Electrical Performance:

	Test Conditions	Performance		
Contact Resistance	Measured at small current (10mA	50mΩ Max.		
	1000Hz or less)			
	Apply a voltage of 500V DC			
	shall be applied for 1 minute after			
	which measurement taken:			
	(1) Between terminals not to			
Insulation Resistance	be contact	100MΩ Min.		
	(2) Between body and	TOOMIS2 WIIII.		
	terminal			
	(3) Between terminals not to			
	be contact when plug is			
	inserted			
Dielectric Strength	AC500V rms (50-60Hz) for 1			
	minute trip current: 0.5mA			
	(1) Between terminals not to			
	be contact.	Without damage to parts arcing or breakdown		
	(2) Between body and			
	terminal			
	(3) Between terminals not to			
	be contact when plug is			
	inserted.			

4) Mechanical Performance:

	Test Conditions	Performance	
Insertion Force	Measurement shall be made after 3		
msertion Porce	times of insertion and extraction with	500~1000 gf	
	gauge plug		
	Measurement shall be made after 3		
Extraction Force	times of insertion and extraction with	300~800 gf	
	gauge plug		
	A static load of 150gf shall be applied	Electrical characteristics shall be	
Terminal Strength	to the terminal for 15 seconds in any	satisfied without damage or	
	direction	excessive looseness of terminals	
Life Test	Endurance without load:	(1) Contact resistance: 100mΩ	
	Jack shall be subjected to 5,000	Max.	
	cycles at a rate of 15 to 18 cycles per	(2) Insulation Resistance: 50MΩ Min.	
	minute without loading.	(3) Withstand Voltage: AC 500V	



	(4)	for 1 minute. Without damage to parts
		arcing or breakdown.

5) Environmental Characteristics:

5) Environmental Char	Test Conditions	Performance	
Solderability Test	The top of terminals shall be dipped 2mm in the solder bath of 260±5°C for 3±0.5 seconds	The Area of soldering should be over 75%	
Resistance to Solder Heat Test	Solder Bath method: Solder temperature 260±5°C Immersion Time 3±0.5 seconds Immersion depth up to the surface of the board 1.6mm dimensions of component holes in the printed wiring board shall be in accordance with those specified in this document. Solder iron method: temperature of solder 350±10°C time of solder 3±0.5 sec.	Without deformation of case or excessive looseness of terminals electrical characteristics shall be satisfied.	
Cold Test	The jack shall be stored at a temperature of -25± 3°C for 48 hours, then the switch shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made	There shall be no deformation or cracks in the molded part.	
Heat Test	The jack shall be stored at a temperature of 70±2°C for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.		
Humidity Test	The jack shall be stored at a temperature of 40±2°C and a humidity of 90% to 98% for 48 hours, then the jack shall be maintained at standard atmospheric conditions for 1 hour after which measurement shall be made.	There shall be no deformation or cracks in molded part.	
Tes	t Condition (Unless otherwise specifi Temperature: 5°C - 35°C Humidity: 45% - 85% R.H. Pressure: 86 – 106kPa	ed)	

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